

PATENT**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE****In re Application of:**

Trivedi et al.

Serial No.: 10/000,479**Filed: October 24, 2001****For: LOCAL INTERCONNECT
STRUCTURE FOR INTEGRATED
CIRCUIT DEVICES, SOURCE
STRUCTURE FOR THE SAME, AND
METHOD FOR FABRICATING THE
SAME****Confirmation No.: 4131****Examiner: H. Vu****Group Art Unit: 2811****Attorney Docket No.: 2269-3439.4US
(97-936.3)****CERTIFICATE OF MAILING**

I hereby certify that this correspondence along with any attachments referred to or identified as being attached or enclosed is being deposited with the United States Postal Service as First Class Mail on the date of deposit shown below with sufficient postage and in an envelope addressed to the Commissioner for Patents, Washington, D.C. 20231.

2/5/03

Date

Signature

Joseph A. Walkowski
Name (Type/Print)**RESPONSE TO OFFICE ACTION****Box Non Fee Amendment
Commissioner for Patents
Washington, D.C. 20231****Sir:**

The following amendments and remarks are filed in response to the Examiner's remarks in the Office Action mailed November 5, 2002, the three-month shortened statutory period for response to which expires on February 5, 2002.

FAX RECEIVED**OCT 01 2003****PETITIONS OFFICE****RECEIVED****OCT 03 2003****OFFICE OF PETITIONS**